Form PTO-1449

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

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Docket Number (Optional) 3640.2US (97-1175.02/US) Application Number

N ty tassigned

Applicant St v n J. Simm ns

Filing Date August 29, 2003

Group Art Unit Unkn wn

XAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DA	
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2/	5,103,166	04/1992	Jeon et al.				
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		ОТ	HER DOCUMENTS	(including	Author, Title, Da	te, Pertinent F	Pages, Etc.)
35C	IEEE Inte	, "Optical Inspect mational Worksh	HER DOCUMENTS ion of Wafers Using Large-Area op on Defect and Fault Toleran	a Defect Dete	ection and S	ampling",	, The
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not considered. Include copy of this form with n xt communication to the applicant.